

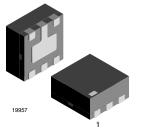
5-Line ESD Protection Diode Array in LLP75-6A

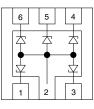
Features

- Ultra compact LLP75-6A package
- 5-line ESD-protection
- Surge immunity acc.
 IEC 61000-4-5 I_{PPM} > 12 A
- Low leakage current $I_R < 1 \mu A$
- ESD-immunity acc. IEC 61000-4-2
 - ± 30 kV contact discharge
 - ± 30 kV air discharge
- Working voltage range V_{RWM} = 5 V
- · Lead (Pb)-free component
- Component in accordance to RoHS 2002/95/EC and WEEE 2002/96/EC









1998

Marking (example only)



Dot = Pin 1 marking XX = Date code YY = Type code (see table below)

Ordering Information

Device name	Device name Ordering code		Minimum order quantity	
GMF05C-HS3	GMF05C-HS3-GS08	3000	15000	

Package Data

Device name	Package name	Type code	Weight	ght compound Moisture sensitivity level Solde flammability rating		Soldering conditions
GMF05C-HS3	LLP75-6A	F5	5.2 mg	UL 94 V-0	MSL level 1 (according J-STD-020)	260 °C/10 s at terminals

^{*} Please see document "Vishay Green and Halogen-Free Definitions (5-2008)" http://www.vishay.com/doc?99902



Absolute Maximum Ratings

Rating	Test condition			Value	Unit
Peak pulse current	BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2); acc. IEC 61000-4-5; $t_p = 8/20~\mu s$; single shot			12	Α
Peak pulse power	BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2); acc. IEC 61000-4-5; $t_p = 8/20~\mu s$; single shot			200	w
ESD immunity	acc. IEC61000-4-2; 10 pulses BiAs-mode: each input (pin 1; 3 - pin 6) to ground (pin 2)	contact discharge	V _{ESD}	± 30	kV
		air discharge	V _{ESD}	± 30	kV
Operating temperature	Junction temperature			- 55 to + 125	°C
Storage temperature			T _{STG}	- 55 to + 150	°C

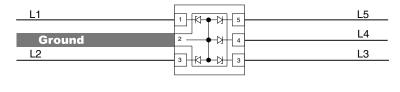
BiAs-Mode (5-line Bidirectional Asymmetrical protection mode)

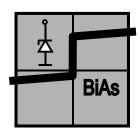
With the **GMF05C-HS3** up to 5 signal- or data-lines (L1 - L5) can be protected against voltage transients. With pin 2 connected to ground and pin 1; 3 up tp pin 6 connected to a signal- or data-line which has to be protected. As long as the voltage level on the data- or signal-line is between 0 V (ground level) and the specified **M**aximum **R**everse **W**orking **V**oltage (**V**_{RWM}) the protection diode between data line and ground offer a high isolation to the ground line. The protection device behaves like an open switch.

As soon as any positive transient voltage signal exceeds the break through voltage level of the protection diode, the diode becomes conductive and shorts the transient current to ground. Now the protection device behaves like a closed switch. The Clamping Voltage (V_C) is defined by the BReakthrough Voltage (V_{BR}) level plus the voltage drop at the series impedance (resistance and inductance) of the protection device.

Any negative transient signal will be clamped accordingly. The negative transient current is flowing in the forward direction of the protection diode. The low Forward Voltage (V_F) clamps the negative transient close to the ground level.

Due to the different clamping levels in forward and reverse direction the **GMF05C-HS3** clamping behaviour is **Bi**directional and **As**ymmetrical (**BiAs**).





20739

2



Electrical Characteristics

Ratings at 25 °C, ambient temperature unless otherwise specified

GMF05C-HS3

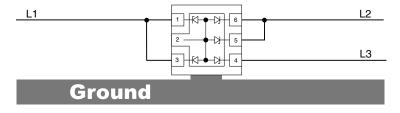
BiAs mode: each input (pin 1; 3 - pin 6) to ground (pin 2)

Parameter	Test conditions/remarks	Symbol	Min.	Тур.	Max.	Unit
Protection paths	number of line which can be protected	N lines			5	lines
Reverse working voltage	at I _R = 1 μA	V _{RWM}	5			V
Reverse current	at V _R = V _{RWM} = 5 V	I _R		< 0.1	1	μΑ
Reverse breakdown voltage	at I _R = 1 mA	V _{BR}	6		8	V
Reverse clamping voltage	at I _{PP} = 12 A acc. IEC 61000-4-5	V _C			12.5	V
	at I _{PP} = 1 A acc. IEC 61000-4-5	V _C		7.8	9.5	V
Forward clamping voltage	at I _F = 12 A acc. IEC 61000-4-5	V _F			5.5	V
	at I _{PP} = 1 A acc. IEC 61000-4-5	V _F		1.5		V
Capacitance	at V _R = 0 V; f = 1 MHz	C _D		126	150	pF
	at V _R = 2.5 V; f = 1 MHz	C _D		76		pF

If a higher surge current or Peak Pulse current (I_{PP}) is needed, some protection diodes in the GMF05C-HS3 can also be used in parallel in order to "multiply" the performance.

If two diodes are switched in parallel you get

- double surge power = double peak pulse current (2 x I_{PPM})
- half of the line inductance = reduced clamping voltage
- half of the line resistance = reduced clamping voltage
- double line Capacitance (2 x C_D)
- double Reverse leakage current (2 x I_R)



20740

VISHAY.

Typical Characteristics

T_{amb} = 25 °C, unless otherwise specified

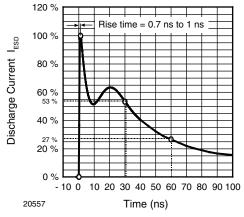


Figure 1. ESD Discharge Current Wave Form acc. IEC 61000-4-2 (330 $\Omega/150$ pF)

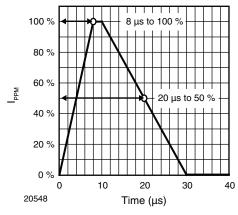


Figure 2. 8/20 µs Peak Pulse Current Wave Form (acc. IEC 61000-4-5)

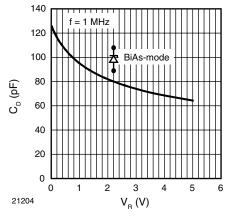


Figure 3. Typical Capacitance C_D vs. Reverse Voltage V_R

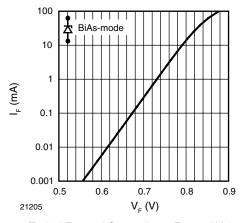


Figure 4. Typical Forward Current I_F vs. Forward Voltage V_F

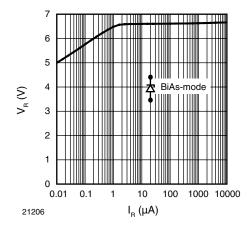


Figure 5. Typical Reverse Voltage V_R vs. Reverse Current I_R

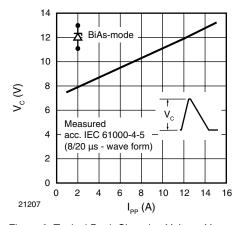


Figure 6. Typical Peak Clamping Voltage $V_{\mathbb{C}}$ vs. Peak Pulse Current $I_{\mathbb{PP}}$



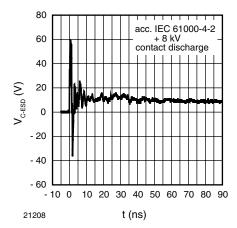


Figure 7. Typical Clamping Performance at + 8 kV Contact Discharge (acc. IEC 61000-4-2)

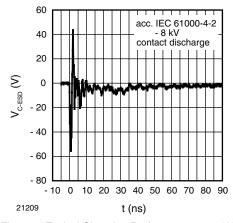


Figure 8. Typical Clamping Performance at - 8 kV Contact Discharge (acc. IEC 61000-4-2)

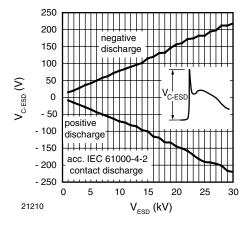
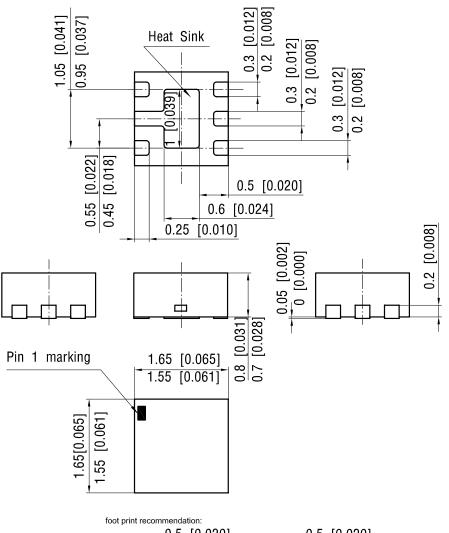
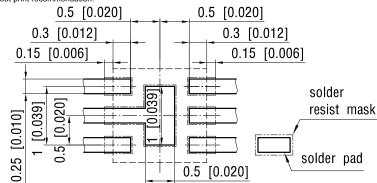


Figure 9. Typical Peak Clamping Voltage at ESD Contact Discharge (acc. IEC 61000-4-2)

VISHAY.

Package Dimensions in millimeters (inches): LLP75-6A





Document no.: S8-V-3906.02-001 (4) Created - Date: 20.December 2004 Rev. b - Date: 12.January 2006

18058



Ozone Depleting Substances Policy Statement

It is the policy of Vishay Semiconductor GmbH to

- 1. Meet all present and future national and international statutory requirements.
- Regularly and continuously improve the performance of our products, processes, distribution and operating systems with respect to their impact on the health and safety of our employees and the public, as well as their impact on the environment.

It is particular concern to control or eliminate releases of those substances into the atmosphere which are known as ozone depleting substances (ODSs).

The Montreal Protocol (1987) and its London Amendments (1990) intend to severely restrict the use of ODSs and forbid their use within the next ten years. Various national and international initiatives are pressing for an earlier ban on these substances.

Vishay Semiconductor GmbH has been able to use its policy of continuous improvements to eliminate the use of ODSs listed in the following documents.

- 1. Annex A, B and list of transitional substances of the Montreal Protocol and the London Amendments respectively.
- 2. Class I and II ozone depleting substances in the Clean Air Act Amendments of 1990 by the Environmental Protection Agency (EPA) in the USA.
- 3. Council Decision 88/540/EEC and 91/690/EEC Annex A, B and C (transitional substances) respectively.

Vishay Semiconductor GmbH can certify that our semiconductors are not manufactured with ozone depleting substances and do not contain such substances.

We reserve the right to make changes to improve technical design and may do so without further notice.

Parameters can vary in different applications. All operating parameters must be validated for each customer application by the customer. Should the buyer use Vishay Semiconductors products for any unintended or unauthorized application, the buyer shall indemnify Vishay Semiconductors against all claims, costs, damages, and expenses, arising out of, directly or indirectly, any claim of personal damage, injury or death associated with such unintended or unauthorized use.

Vishay Semiconductor GmbH, P.O.B. 3535, D-74025 Heilbronn, Germany

Document Number 85654 Rev. 1.8, 23-Sep-08



Vishay

Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.

Revision: 18-Jul-08

Document Number: 91000 www.vishay.com